



Preparation of the Silicon Tracking System for CBM/FAIR: progress towards production readiness



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WP2.1

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Silicon Tracking System of the CBM experiment





Beam-target interactions rates up to 10 MHz

- Aims at multi-strange hyperon reconstruction
- Tracking challenge:
 - up to 700 ch. particle tracks/coll. in aperture
 - low momentum \rightarrow low mat. budget (3:8%X₀)
 - spatial (< 30 μ m) + timing (< 5 ns) + amplitude (15 fC/5 bit) information collected in selftriggering mode

essed nuclear matter in high-rate heavy-ion collisions

Silicon Tracking System







STS structure and assembly sequence



- 876 modules, 106 ladders, & 14 000 r/o ASICs, & 7 000 LDOs

• Large number of unique components: 199 module variants, 38 ladder types



Upgradable STS concept



- detailed comparison using a simulation approach:
- updated geometry, acceptance, material budget, tracking performance

Modular STS setup for improved maintenance, upgradability and replacement









Tracking performance at 12 AGeV/c



Module assembly STS detector modules are produced in the assembly centers at GSI and KIT











Pre-series production successfully started in early 2022 to validate the sequence

- tools and procedures shared between assembly centers
- highly integrated objects: extensive testing at each step





Module acceptance test: reception, calibration, thermal cycling

Module installed into the carrier structure with interfaces for testing







Module baseline width measurement

ADC calibration of the SMX ASIC



Thermal cycling climate chamber: $+25^{\circ}C..-40^{\circ}C$







Ladder assembly sequence

- From 8 to 10 detector modules installed on the light-weight carbon structures: ladders
- Sensors precisely positioned ($\leq 30 \mu m$) with jigs



- Assembled ladders undergo metrology survey and functionality tests
- After tests ladder is installed on C-frame using transfer tool











Optical metrology and ladder functionality tests



- multi-point probing
- <u>Optical metrology</u>: dedicated table with camera • $\mathcal{O}(10 \ \mu m)$ measured precision lacksquare

- QC with <u>assembled ladder</u>: DAQ communication test
- HV (spark) test \bullet





Actual sensor position is stored in the database

- flexible design to mount every type of ladder
- Dimensions: 1500mm x 400mm x 110mm
- Weight: ≈ 40 kg







Pre-series module assembly

10 STS modules on ladders to be prepared for the E16 experiment (J-PARC). Beam test: spring 2023



Assembled modules



Ladders





Module testing in the **test box** or in **module carrier**







Module final performance

Two module mounted onto ladders ENC [e]



- 8/10 tested
- fully functional ✓
- detailed study of all settings done 🗸
- installation on ladders ongoing \checkmark
- first ladders shipped to J-PARC







Conclusions

- Upgradable/modular setup of STS (3+5 stations): performance estimated, comparable to STS8 setup
- Quality control of system components finished
- Assembly procedure and acceptance tests for detector modules determined
- Pre-series batch of detector modules produced, performance OK.
- Modules integrated onto ladders following optical metrology and electrical quality control.



Construction status



Synchrotron ring SIS100 with transfer line CBM cave from SIS18 and extraction line to CBM cave



Double-sided silicon micro strip sensors

20 °C [µA]

0

0.



- Four sensor form factors
- All 1100 sensors characterized
- Automated optical defect detection and classification
- Electrical QC (capacitance- and current-voltage characteristics)



Current-voltage curve Capacitance-voltage curve

Sensor characteristics measured at Tuebingen University.

dust grain	scratch	R bias/DC pads	AC pa
tus 250 μm	scratch	dc_pabias_dc_pa,bias_dc_pa,bias_resista	ac_pad ac_pad Image: state s

Different object/defect classes located and classified with neural networks









- Overall length from 160mm to 495mm



Production/QC ongoing at LTU, Kharkiv (60% of ~15 000 cables already at GSI)





Front-end electronics finalizing the design







- 8 SMX2.2 r/o ASICs (à 128 ch.)
- Custom designed LDOs
- Versions with 2 and 5 data links
- 2 FEBs per module
- HV stability ±250 V
- Service connector for fast powering (e.g., module testing)
- Filtering scheme optimized



Updated FEB schematics with service connector + on-board HV filter



Circuit parameter optimization

